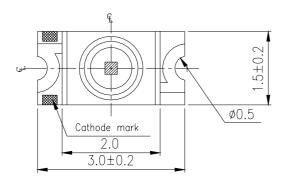
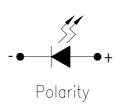
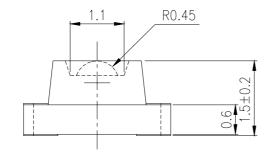


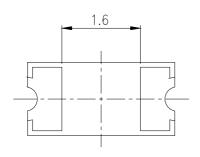
### **Package Outline Dimensions**

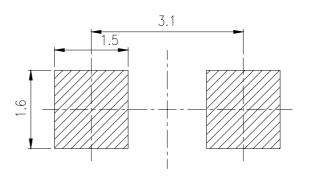






For reflow soldering (propose)





**Note:** Tolerances Unless Dimension  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-111-008 http://www.everlight.com

Rev 1

Page: 2 of 9

Prepared date: 17-Aug-2005 Prepared by: Meng Yali



# EVERLIGHT ELECTRONICS CO.,LTD.

# 11-21SURC/S530-XX/TR8

### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IF	60	mA	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec.  Hand Soldering : 350 °C for 3 sec.		

### **Electro-Optical Characteristics (Ta=25°C)**

1							
Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity		A2	29	71			
		A3	68	102			
	Iv	A4	93	138		mcd	
		A5	112	172			
		A6	135	208			
Viewing Angle	2 \theta 1/2			60		deg	I <sub>F</sub> =20mA
Peak Wavelength	λр			632		nm	IF-ZUIIIA
Dominant Wavelength	λd			624		nm	
Spectrum Radiation Bandwidth	Δλ			20		nm	
Forward Voltage	VF		1.7	2.0	2.4	V	
Reverse Current	Ir				10	$\mu$ A	V <sub>R</sub> =5V

# \*11-21SURC/S530<u>-XX/</u>TR8



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Rev 1

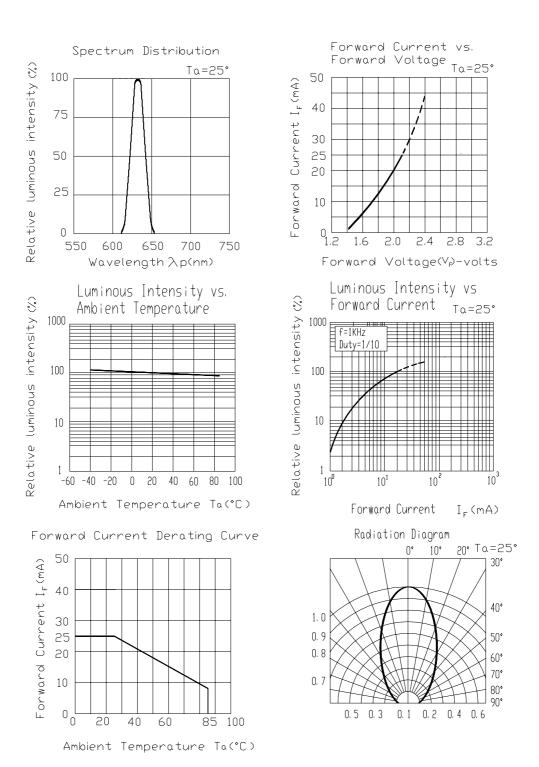
Page: 3 of 9

Device No:SZDSE-111-008

Prepared date: 17-Aug-2005



## **Typical Electro-Optical Characteristics Curves**



Everlight Electronics Co., Ltd. Device No:SZDSE-111-008

http://www.everlight.com Prepared date: 17-Aug-2005 Rev 1

Page: 4 of 9



## **Label explanation**

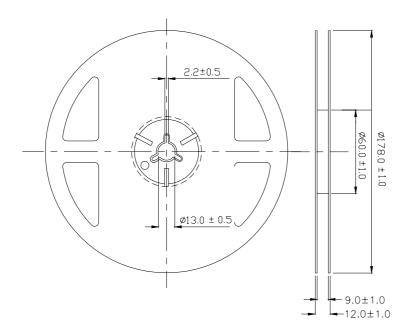
**CAT: Luminous Intensity** 

**HUE: Dom. Wavelength** 

**REF: Forward Voltage** 



#### **Reel Dimensions**



**Note:** Tolerances Unless Dimension  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-111-008

http://www.everlight.com

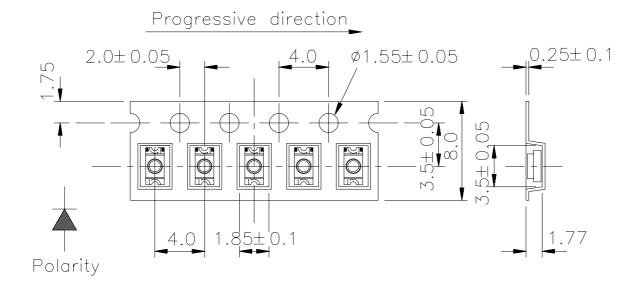
Rev 1

Page: 5 of 9

Prepared date: 17-Aug-2005

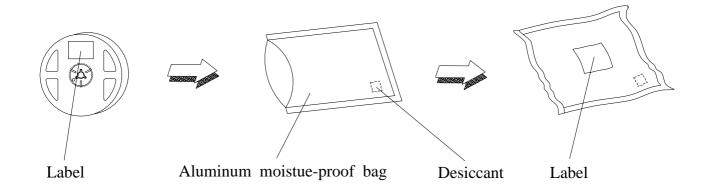


### ■ Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** Tolerances Unless Dimension  $\pm 0.1$ mm, Unit = mm

# **■** Moisture Resistant Packaging



Everlight Electronics Co., Ltd. Device No:SZDSE-111-008

http://www.everlight.com

Prepared date: 17-Aug-2005

Rev 1

Page: 6 of 9



#### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow	Temp. : 260°C±5°C Min. 5 sec.	6 Sec.	22 Pcs.	0/1
2	Temperature Cycle	$H: +100^{\circ}C$ 15 min. $\int 5 \text{ min.}$ $L: -40^{\circ}C$ 15 min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H:+100°C 5 min. ∫ 10 sec. L:-10°C 5 min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -55°℃	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C/RH 85%	1000 Hrs.	22 Pcs.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 7 of 9

Device No:SZDSE-111-008 Prepared date: 17-Aug-2005 Prepared by: Meng Yali

#### **Precautions For Use**

1. Over-current-proof

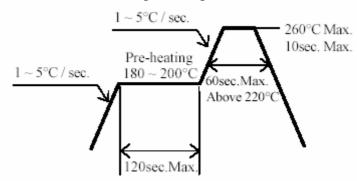
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 8 of 9

Device No:SZDSE-111-008 Prepared date: 17-Aug-2005 Prepared by: Meng Yali

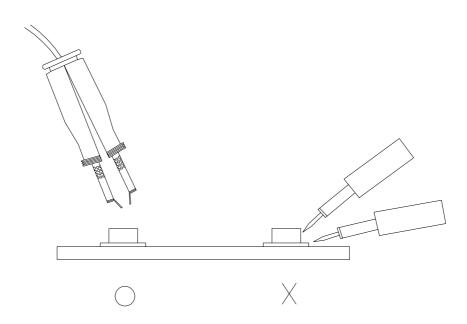


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd,

Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

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Page: 9 of 9